## SDLS144

# SN54LS240, SN54LS241, SN54LS244, SN54S240, SN54S241, SN54S244, SN74LS240, SN74LS241, SN74LS244, SN74S240, SN74S241, SN74S244 OCTAL BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

APRIL 1985 - REVISED MARCH 1988

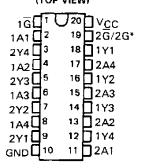
- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- PNP Inputs Reduce D-C Loading
- · Hysteresis at Inputs Improves Noise Margins

### description

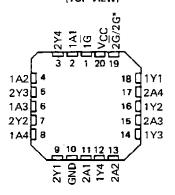
These octal buffers and line drivers are designed specifically to improve both the performance and density of three-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. The designer has a choice of selected combinations of inverting and noninverting outputs, symmetrical  $\overline{G}$  (active-low output control) inputs, and complementary G and  $\overline{G}$  inputs. These devices feature high fan-out, improved fan-in, and 400-mV noise-margin. The SN74LS' and SN74S' can be used to drive terminated lines down to 133 ohms.

The SN54' family is characterized for operation over the full military temperature range of  $-55\,^{\circ}\text{C}$  to 125 $\,^{\circ}\text{C}$ . The SN74' family is characterized for operation from  $0\,^{\circ}\text{C}$  to  $70\,^{\circ}\text{C}$ 

SN54LS', SN54S'...J OR W PACKAGE SN74LS', SN74S'...DW OR N PACKAGE (TOP VIEW)



SN54LS', SN54S'...FK PACKAGE (TOP VIEW)

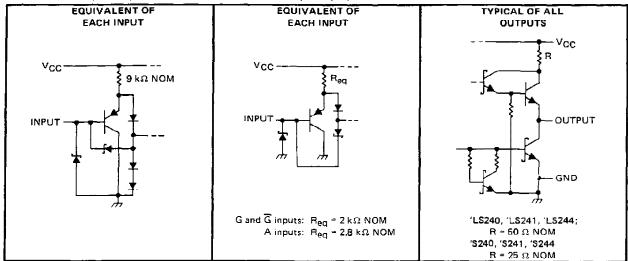


\*2G for 'LS241 and 'S241 or 2G for all other drivers.

### schematics of inputs and outputs

'LS240, 'LS241, 'LS244

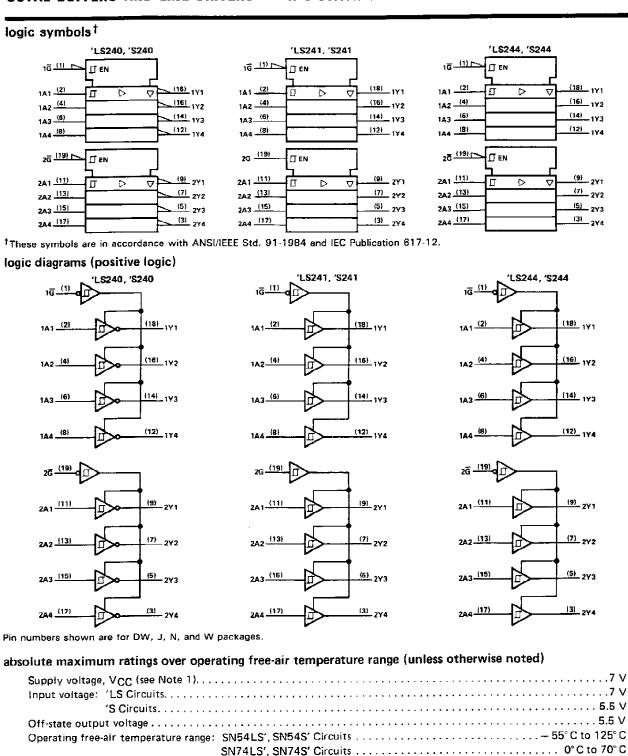
'S240, 'S241, 'S244



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# SN54LS240, SN54LS241, SN54LS244, SN54S240, SN54S241, SN54S244, SN74SL240, SN74LS241, SN74LS244, SN74S240, SN74S241, SN74S244 OCTAL BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS



NOTE 1: Voltage values are with respect to network ground terminal.

# SN54LS240, SN54LS241, SN54LS244, SN74LS240, SN74LS241, SN74LS244 OCTAL BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

### recommended operating conditions

PARAMETER			Ī				
LAUSME1EN	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
V <sub>CC</sub> Supply voltage (see Note 1)	4.5	5	5.5	4.75	5	5.25	V
VIH High-level input voltage	2			2			V
VIL Low-level input voltage			0.7			8.0	V
IOH High-level output current			- 12			- 15	mA
IOL Low-level output current			12			24	mA
TA Operating free-air temperature	- 55		125	0		70	°C

NOTE 1: Voltage values are with respect to network ground terminal.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	DAMETER		TEST CONDITI	ouet	SN54LS' S			SN74L	S'		
PA	ARAMETER		TEST CONDITI		MIN	TYP‡	MAX	MIN	TYP‡	0.4 0.5 20 - 20 0.1 20 - 22 27 44 46 50 54	UNIT
	κ	V <sub>CC</sub> = MIN,	I <sub>I</sub> = — 18 mA		T		<b>– 1.5</b>			- 1.5	V
1	teresis V <sub>T</sub> _)	V <sub>CC</sub> = MIN			0.2	0.4		0.2	0.4		٧
V		V <sub>CC</sub> = MIN, I <sub>OH</sub> = -3 mA	V <sub>IH</sub> = 2 V,	VIL = MAX,	2.4	3.4		2.4	3.4		
\ \v_c	ЭН	V <sub>CC</sub> = MIN, I <sub>OH</sub> = MAX	V <sub>1H</sub> = 2 V,	V <sub>IL</sub> = 0.5 V,	2			2			
		V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	I <sub>OL</sub> = 12 mA	T		0.4			0.4	V
\ v <sub>c</sub>	)L	V <sub>IL</sub> = MAX		IOL = 24 mA						0.5	1 <u> </u>
lo	ZH	V <sub>CC</sub> = MAX,	V <sub>IH</sub> = 2 V,	V <sub>O</sub> = 2.7 V			20			20	μА
Ō	ZL	V <sub>IL</sub> = MAX		V <sub>O</sub> = 0.4 V	<u> </u>		20			<b>– 20</b>	۳۸
11		VCC = MAX,	V <sub>1</sub> = 7 V		]		0.1			0.1	mA
ելլ	t	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.7 V		<u></u>		20	l		20	μА
կլ		V <sub>CC</sub> = MAX,	V <sub>IL</sub> = 0.4 V		]		- 0.2	l		0.2	mΑ
lo	\$§	V <sub>CC</sub> = MAX			-40		<b>– 22</b> 5	-40		- 225	mΑ
	Outputs high			All	]	17	27		17	27	
İ	Outputs low	V <sub>CC</sub> = MAX,		'LS240		26	44		26	44	]
lac	Outputs low	Output open		'LS241, 'LS244	].	27	46		27	46	mA
	All outputs	Cathat obei		'L\$240		29	50		29	50	
	disabled			'LS241, 'LS244		32	54		32	54	

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

# switching characteristics, VCC = 5 V, TA = 25°C

	TEST CONDITIONS		'LS240			LS			
PARAMETER	1EST CON	מאטווועה.	MIN	TYP         MAX         MIN         TYP         MA           9         14         12         1           12         18         12         1           20         30         20         3           15         23         15         2	MAX	UNIT			
<sup>t</sup> PLH	<del>-</del> "			9	14	_	12	18	ns
<sup>t</sup> PHL	RL = 667 Ω, See Note 2	Cլ = 45 pF,		12	18		12	18	пѕ
tPZL				20	30		20	30	пъ
tPZH				15	23		15	23	ns
<sup>t</sup> PLZ	R <sub>L</sub> = 667 Ω,	CL = 5 pF,		10	20		10	20	ns
tPHZ	See Note 2			15	25		15	25	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



<sup>‡</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. § Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

# SN54S240, SN54S241, SN54S244, SN74S240, SN74S241, SN74S244, OCTAL BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

recommended operating	

	DADAMETER	SN54S'				SN74S'			
	PARAMETER	MIN	NOM	MAX	MIN	NOM	MAX 5.25 0.8 - 15 64 40	UNIT	
Vcc	Supply voltage, (see Note 1)	4.5	5	5.5	4,75	5	5.25	V	
ViH	High-level input voltage	2			2			V	
٧IL	Low-level input voltage			0.8			8.0	V	
јон	High-level output current		_	12			- 15	mΑ	
ГОL	Low-level output current			48		_	64	mΑ	
	External resistance between any input and VCC or ground			40			40	kΩ	
$T_{A}$	Operating free-air temperature (see Note 3)	<b>– 55</b>		125	0		70	°C	

NOTES: 1. Voltage values are with respect to network ground terminal,

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

			TEAT 0010171	aunt		SN54S	,		<u> </u>	Τ	
PARAMETER  VIK  Hysteresis (VT+ - VT_)  VOH  VOL  IOZH IOZL II IIH IL Any A Any G IOS§  Outputs high	HAMEIER	TEST CONDITIONS		MIN	TYP‡	MAX	MIN	TYP	MAX	UNIT	
VIE	<del></del>	V <sub>CC</sub> = MIN,	I <sub>I</sub> = - 18 mA				- 1.2	1	_	1.2	V
•		V <sub>CC</sub> = MIN			0.2	0.4		0.2	0.4		٧
		V <sub>CC</sub> = MIN, I <sub>OH</sub> = - 1 mA	V <sub>IH</sub> = 2 V,	V <sub>IL</sub> = 0.8 V,				2.7			
٧o	н	V <sub>CC</sub> = MIN, I <sub>OH</sub> = - 3 mA	V <sub>IH</sub> = 2 V,	V <sub>IL</sub> = 0.8 V,	2.4	3.4		2.4	3.4		v
		V <sub>CC</sub> = MIN, I <sub>OH</sub> = MAX	V <sub>1H</sub> = 2 V,	V <sub>IL</sub> = 0.5 V,	2			2			
٧o	L	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	V <sub>IL</sub> = 0.8 V,			0.55			0.55	v
loz	.H	VCC - MAX,	V <sub>IH</sub> = 2 V,	V <sub>O</sub> = 2.4 V			50			50	
loz	?L	V <sub>IL</sub> = 0.8 V,		V <sub>O</sub> = 0.5 V			- 50			- 50	μА
T <sub>I</sub>		VCC = MAX.	V 1 = 5.5 V			· <del></del>	1			1	mΑ
ήн		V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.7 V				50		_	50	μA
ΙΙL		V <sub>CC</sub> - MAX,	V <sub>I</sub> = 0.5 V		Ţ		- 400 - 2			- 400 - 2	μA mA
los	§	V <sub>CC</sub> = MAX	*··* <del>**</del>	-	- 50		- 225	- 50		- 225	mΑ
				'S240		80	123		80	135	
	Outputs high			'S241, 'S244		95	147		95	160	
,	0	V - MAY	0	'S240		100	145		100	0.55 50 - 50 - 400 - 2 - 225 135	^
ICC	Outputs low	VCC = MAX.	TEST CONDITIONS¹         MIN TYP‡ MAX         MIN TYP‡ MAX         MIN TY           I   = -18 mA         -1.2         0.2 0.4         0.2 0.           V   H = 2 V,         V   L = 0.8 V,         2.4 3.4         2.4 3.           V   H = 2 V,         V   L = 0.5 V,         2         2           V   H = 2 V,         V   L = 0.8 V,         0.55           V   H = 2 V,         V   L = 0.8 V,         0.55           V   H = 2 V,         V   C = 2.4 V         50           V   - 5.5 V         1         V           V   - 2.7 V         50         -400           V   - 0.5 V         -50         -225           -50         -225         -50           Outputs open         S240         80         123           'S240         100         145         100           'S240         100         145         100           'S240         100         145         100           'S240         100         145         100	120	180	mA					
	Outputs			'S <b>24</b> 0		100	145		100	150	
	disabled			'S241, 'S244		120	170		120	180	

 $<sup>^\</sup>dagger$  For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>3.</sup> An SN54S241J operating at free-air temperature above 116°C requires a heat sink that provides a thermal resistance from case to free-air  $R_{\theta CA}$ , of not more than 40°C/W.

I All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

<sup>§</sup>Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

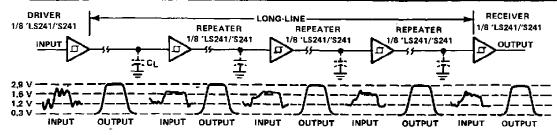
# SN54S240, SN54S241, SN54S244, SN74S240, SN74S241, SN74S244, OCTAL BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

# switching characteristics, VCC = 5 V, $T_A = 25^{\circ}C$

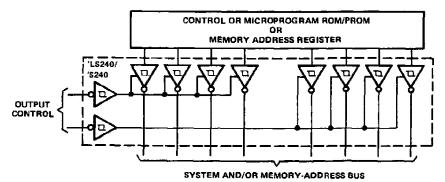
BADAMETED	TECT CO.	TEST CONDITIONS		'S240			'S241, 'S244				
PARAMETER	1691 00	MUITIONS	MIN TYP	MAX	MIN	TYP	MAX	UNIT			
<sup>t</sup> PLH			4.5	7		6	9	ns			
tPHL_	RL = 90 Ω, See Note 4	C <sub>L</sub> = 50 pF,	4.5	7		6	9	ns			
tPZL.			10	15		10	15	пş			
<sup>t</sup> PZH			6.5	10		8	12	П\$			
tplZ	R <sub>L</sub> = 90 Ω,	C∟≒5pF,	10	15		10	15	ns			
<sup>t</sup> PHZ	See Note 4		6	9		6	9	ns			

.... NOTE 4: Load circuits and voltage waveforms are shown in Section 1.

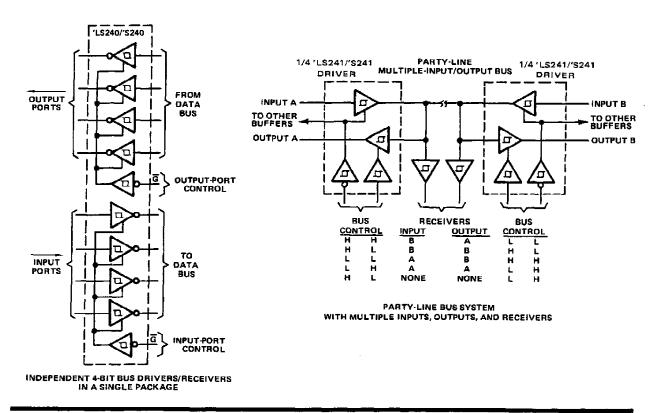
SN54LS240, SN54LS241, SN54LS244, SN54S240, SN54S241, SN54S244, SN74LS240, SN74LS241, SN74LS244, SN74S240, SN74S241, SN74S244 OCTAL BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS



'LS241, 'S241 USED AS REPEATER/LEVEL RESTORER



'LS240/'S240 USED AS SYSTEM AND/OR MEMORY BUS DRIVER-4-BIT ORGANIZATION CAN BE APPLIED TO HANDLE BINARY OR BCD



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